

## FMV16N60ES

**FUJI POWER MOSFET** 

### Super FAP-E<sup>3S</sup> series

#### **N-CHANNEL SILICON POWER MOSFET**

#### ■ Features

Maintains both low power loss and low noise Lower R<sub>DS</sub>(on) characteristic More controllable switching dv/dt by gate resistance Smaller V<sub>GS</sub> ringing waveform during switching Narrow band of the gate threshold voltage (4.2±0.5V) High avalanche durability

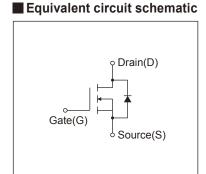
#### Applications

Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

#### Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

# ■ Outline Drawings [mm] TO-220F(SLS)



Description	Symbol	Characteristics	Unit	Remarks	
Duain Course Voltage	V <sub>DS</sub>	600	V		
Drain-Source Voltage	V <sub>DSX</sub>	600	V	V <sub>GS</sub> = -30V	
Continuous Drain Current	In	±16	А		
Pulsed Drain Current	IDP	±64	А		
Gate-Source Voltage	V <sub>GS</sub>	±30	V		
Repetitive and Non-Repetitive Maximum AvalancheCurrent	IAR	16	А	Note*1	
Non-Repetitive Maximum Avalanche Energy	Eas	554.8	mJ	Note*2	
Repetitive Maximum Avalanche Energy	Ear	9.5	mJ	Note*3	
Peak Diode Recovery dV/dt	dV/dt	3.8	kV/μs	Note*4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5	
Maximum Bawar Dissination	PD	2.16	W	Ta=25°C	
Maximum Power Dissipation		95	VV	Tc=25°C	
Oneveting and Stavens Temperature vans	Tch	150	°C		
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to + 150	°C		
Isolation Voltage	Viso	2	kVrms	t = 60sec, f = 60Hz	

#### ● Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS</sub> (th)	I <sub>D</sub> =250µA, V <sub>DS</sub> =V <sub>GS</sub>		3.7	4.2	4.7	V
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	μA
	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V		10	100	nA
Drain-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =8A, V <sub>GS</sub> =10V		-	0.40	0.47	Ω
Forward Transconductance	<b>g</b> fs	I <sub>D</sub> =8A, V <sub>DS</sub> =25V		5	10	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =25V V <sub>GS</sub> =0V		-	2100	3150	pF
Output Capacitance	Coss			-	230	345	
Reverse Transfer Capacitance	Crss	f=1MHz	-	13	19.5		
Turn-()n Time	td(on)	V <sub>cc</sub> =300V V <sub>ds</sub> =10V I <sub>D</sub> =8A R <sub>G</sub> =18Ω		-	43	64.5	ns
	tr			-	41	61.5	
Turn-Off Time	td(off)			-	94	141	
	tf			-	20	30	
Total Gate Charge	Q <sub>G</sub>	1/ 0001/			56	114	nC
Gate-Source Charge	Qss	V <sub>cc</sub> =300V		-	20	25.5	
Gate-Drain Charge	Q <sub>GD</sub>	U <sub>GS</sub> =10V	- I <sub>D</sub> =16A		21	33	
Gate-Drain Crossover Charge	Qsw	VGS = 10 V		-	9.5	10	
Avalanche Capability	lav	L=1.74mH, T <sub>ch</sub> =25°C		16	-	-	А
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =16A, V <sub>GS</sub> =0V, T <sub>ch</sub> =25°C		-	0.90	1.35	V
Reverse Recovery Time	trr	I <sub>F</sub> =16A, V <sub>GS</sub> =0V		-	0.7	-	μS
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	9.0	-	μC

#### Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to case			1.320	°C/W
	Rth (ch-a)	Channel to ambient			58.0	°C/W

Note \*1 : Tch≤150°C

Note \*2 : Stating Tch=25°C, Ias=7A, L=20.8mH, Vcc=60V, Rc=50Ω

Eas limited by maximum channel temperature and avalanche current.

See to 'Avalanche Energy' graph.

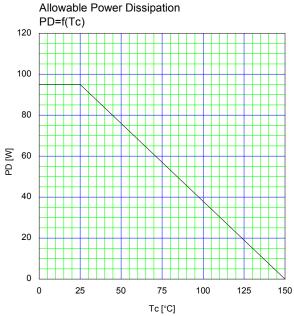
Note  $^{\star}3$  : Repetitive rating : Pulse width limited by maximum channel temperature

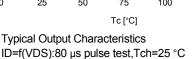
See to the 'Transient Themal impeadance' graph.

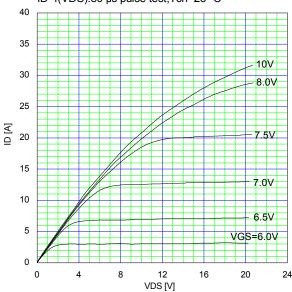
Note \*4 : Ir≤-Ip, -di/dt=100A/µs, Vcc≤BVbss, Tch≤150°C.

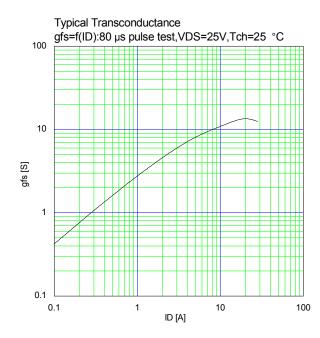
Note \*5 : Ir≤-Ip, dv/dt=3.8kV/µs, Vcc≤BVbss, Tch≤150°C.

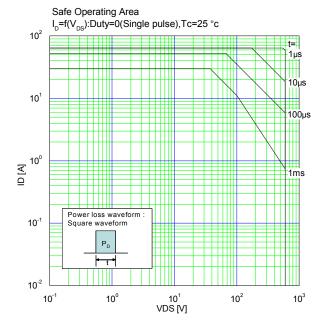
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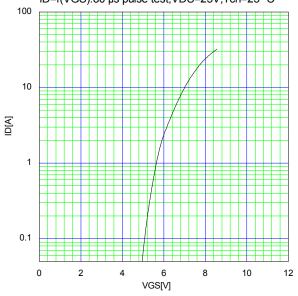


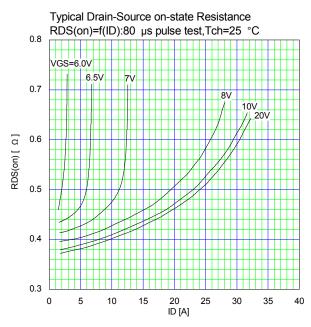




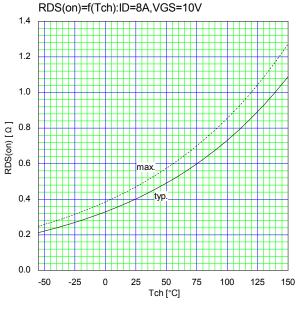


Typical Transfer Characteristic ID=f(VGS):80 µs pulse test,VDS=25V,Tch=25 °C

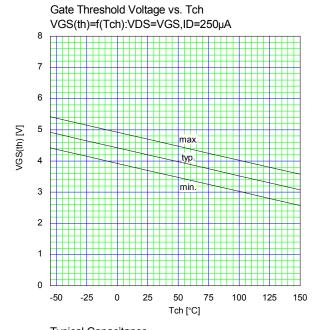


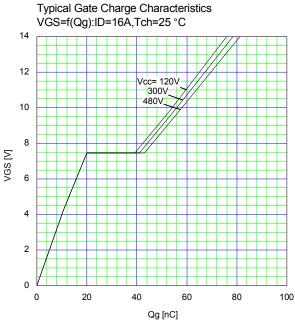


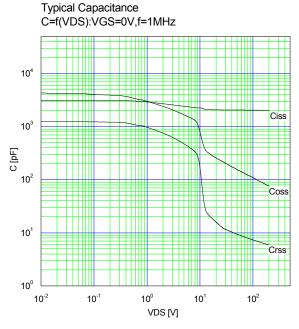
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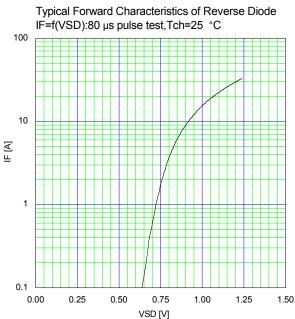


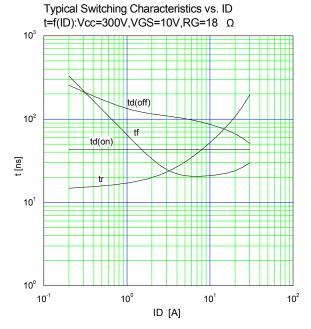
Drain-Source On-state Resistance

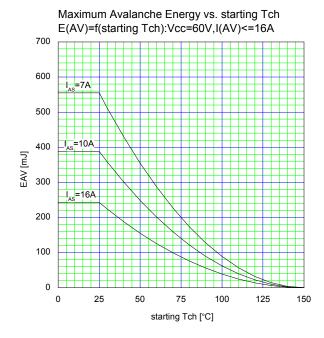


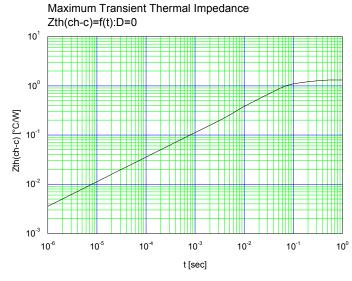












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